DATASHEET

1.6mm round Subminiature Infrared LED IR26-21C/L447/CT



Features

- Small double-end package
- Low forward voltage
- · Good spectral matching to Si photo detector
- . Package in 12mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free.(Br<900 ppm,Cl<900 ppm,Br+Cl<1500 ppm)

Descriptions

- IR26-21C/L447/CT is an infrared emitting diode in miniature SMDpackage which is molded in a water clear plastic with sphericaltop view lens.
- The device is spectrally matched with siliconLEDs and phototransistor

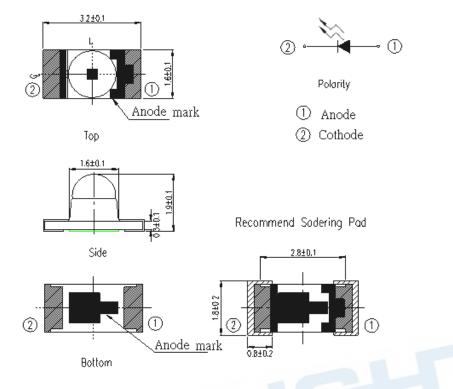
Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

Device Selection Guide

Part Category	Chip Material	Lens Color
IR	GaAlAs	Water Clear

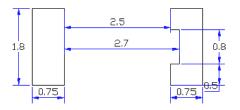
Package Dimensions



- Notes: 1.All dimensions are in millimeters
 - 2. Tolerances unless dimensions ±0.1mm
 - 3.Suggested pad dimension is just for reference only

Please modify the pad dimension based on individual nee

- Solder paste : Sn/Ag3.0/Cu0.5
- Stencil thickness : 0.10mm
- Stencil design drawing :



4. Suggested pad dimension is just for reference only

Please modify the pad dimension based on individual need

Absolute Maximum Ratings (Ta=25°C)

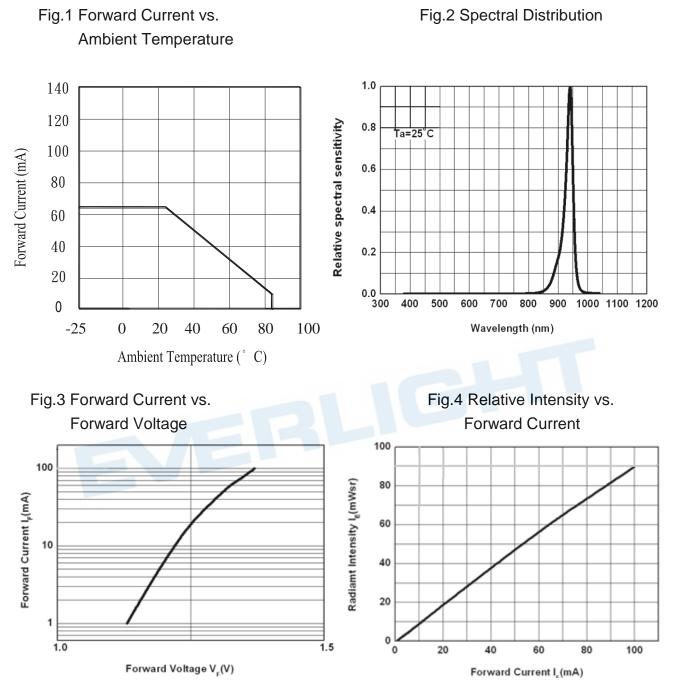
Parameter	Symbol	Rating	Units	
Continuous Forward Current	lF	65	mA	
Reverse Voltage	VR	5	V	
Operating Temperature	T _{opr}	-25 ~ +85	°C	
Storage Temperature	T _{stg}	-40 ~ +85	°C	
Soldering Temperature *1	T _{sol}	260	°C	
Power Dissipation at(or below)	Pd	130	mW	
25°C Free Air Temperature	Id	130		

Notes: *1:Soldering time \leq 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Radiant Intensity	le	I _F =20mA	11	18		mW/sr
Peak Wavelength	λр	I _F =20mA		940		nm
Spectral Bandwidth	Δλ	I _F =20mA		55		nm
Forward Voltage	VF	I⊧=20mA		1.3	1.5	V
Reverse Current	IR	V _R =5V			10	μA
View Angle	201/2	I⊧=20mA		25		deg
				<u> </u>		

Typical Electro-Optical Characteristics Curves



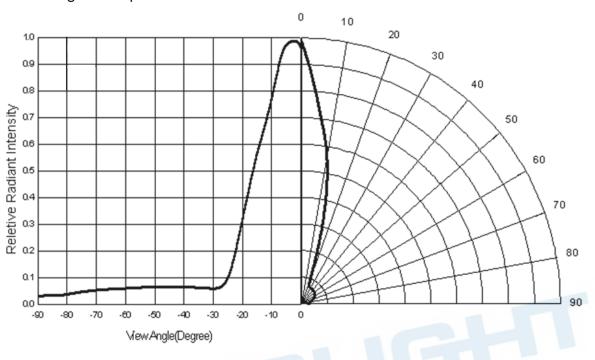
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Typical Electro-Optical Characteristics Curves

Fig.5 Relative Radiant Intensity vs.

Angular Displacement



Precautions For Use

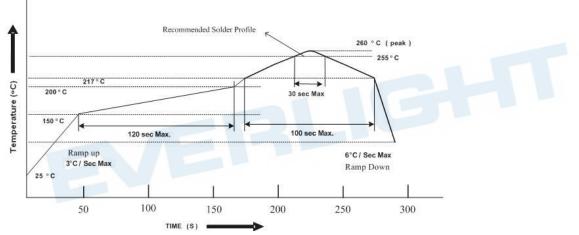
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 After opening the package: The LEDs should be kept at 30 $^\circ\!C$ or less and 60%RH or less.
 - 2.3 The LEDs should be used within 168 hours (7days) after opening the package .
 - 2.4 I If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours 3. Soldering Condition

3.1 Lead solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

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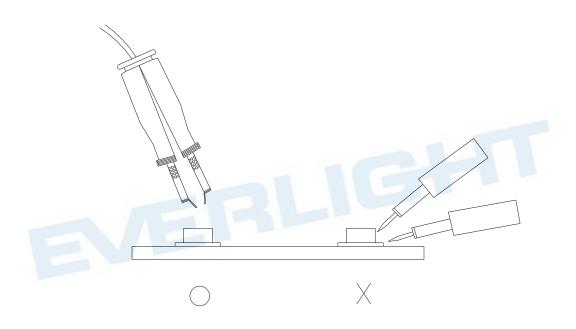
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4.Soldering Iron

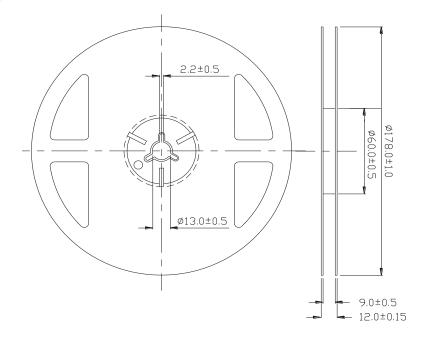
Each terminal is to go to the tip of soldering iron temperature less than 350° for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

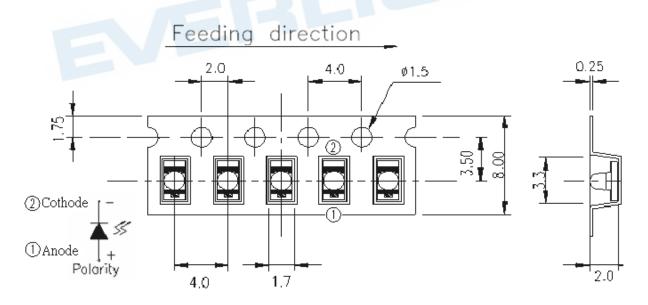


Package Dimensions



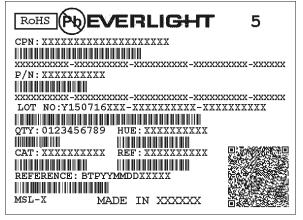
Note: The tolerances unless mentioned is ±0.1mm, Unit: mm

Carrier Taping Dimensions: (Quantity: 1500PCS/Reel)



Note: The tolerances unless mentioned is ±0.1mm, Unit: mm

Label Form Specification



CPN: Customer's Production Number P/N : Production Number LOT No: Lot Number QTY: Packing Quantity HUE: Peak Wavelength CAT: Ranks REF: Reference MSL-X: MSL Level Made In: Manufacture place

Notes

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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- 6. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.

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